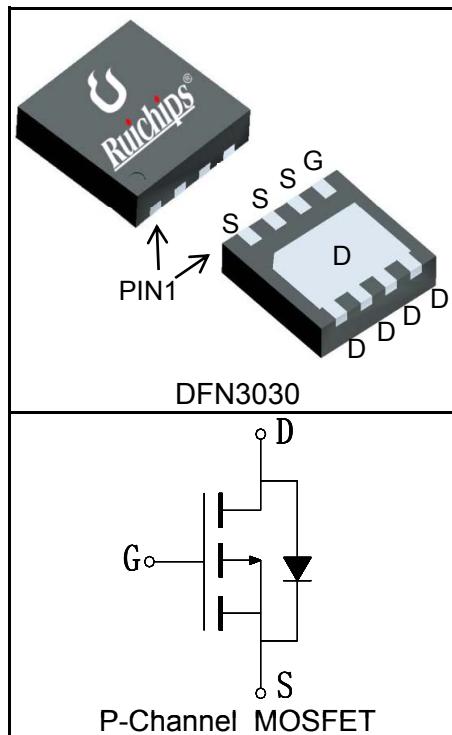


Features

- -30V/-30A,
- $R_{DS(on)} = 10\text{m}\Omega(\text{Typ.}) @ V_{GS} = -10\text{V}$
- $R_{DS(on)} = 18\text{m}\Omega(\text{Typ.}) @ V_{GS} = -4.5\text{V}$
- Uses Ruichips advanced Trench™ technology
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Reliable and Rugged
- 100% avalanche tested
- Lead Free and Green Devices Available (RoHS Compliant)

Pin Description



Applications

- Switching Application Systems
- On Board power for server
- Synchronous rectification

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
Common Ratings ($T_c = 25^\circ\text{C}$ Unless Otherwise Noted)			
V_{DSS}	Drain-Source Voltage	-30	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_c = 25^\circ\text{C}$	-30
Mounted on Large Heat Sink			
$I_{DP}^{(1)}$	300μs Pulse Drain Current Tested	$T_c = 25^\circ\text{C}$	-96
$I_D^{(2)}$	Continuous Drain Current@ $T_c(V_{GS} = -10\text{V})$	$T_c = 25^\circ\text{C}$	-30
		$T_c = 100^\circ\text{C}$	-19
P_D	Maximum Power Dissipation@ $T_c(V_{GS} = -10\text{V})^{(3)}$	$T_A = 25^\circ\text{C}$	-9.3
		$T_A = 70^\circ\text{C}$	-7.5
	Maximum Power Dissipation@ T_c	$T_c = 25^\circ\text{C}$	33
		$T_c = 100^\circ\text{C}$	13
	Maximum Power Dissipation@ T_A	$T_A = 25^\circ\text{C}$	3.5
		$T_A = 70^\circ\text{C}$	2.3

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	3.8	°C/W
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	35	°C/W
Drain-Source Avalanche Ratings			
$E_{AS}^{(4)}$	Avalanche Energy, Single Pulsed	42	mJ

Electrical Characteristics ($T_C=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RU30L30M3			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=-250\mu A$	-30			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-30V, V_{GS}=0V$			-1	μA
		$T_J=125^\circ C$			-30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=-250\mu A$	-1		-2.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 10	μA
$R_{DS(ON)}^{(5)}$	Drain-Source On-state Resistance	$V_{GS}=-10V, I_{DS}=-20A$		10	12	$m\Omega$
		$V_{GS}=-4.5V, I_{DS}=-16A$		18	20	$m\Omega$
Diode Characteristics						
$V_{SD}^{(5)}$	Diode Forward Voltage	$I_{SD}=-20A, V_{GS}=0V$			-1.5	V
t_{rr}	Reverse Recovery Time	$I_{SD}=-20A, dI_{SD}/dt=100A/\mu s$		45		ns
Q_{rr}	Reverse Recovery Charge			26		nC
Dynamic Characteristics⁽⁶⁾						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		1.8		Ω
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=-15V, Frequency=1.0MHz$		2300		pF
C_{oss}	Output Capacitance			250		
C_{rss}	Reverse Transfer Capacitance			160		
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=-15V, I_{DS}=-20A, V_{GEN}=-10V, R_G=6\Omega$		17		ns
t_r	Turn-on Rise Time			32		
$t_{d(OFF)}$	Turn-off Delay Time			37		
t_f	Turn-off Fall Time			15		
Gate Charge Characteristics⁽⁶⁾						
Q_g	Total Gate Charge	$V_{DS}=-24V, V_{GS}=-10V, I_{DS}=-20A$		42		nC
Q_{gs}	Gate-Source Charge			9		
Q_{gd}	Gate-Drain Charge			13		

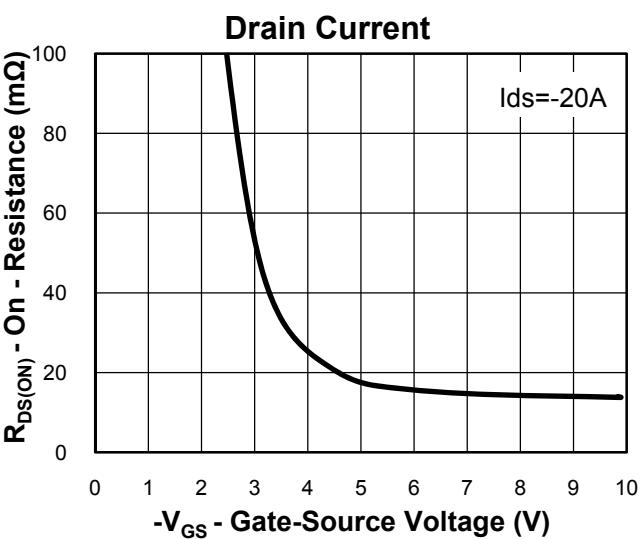
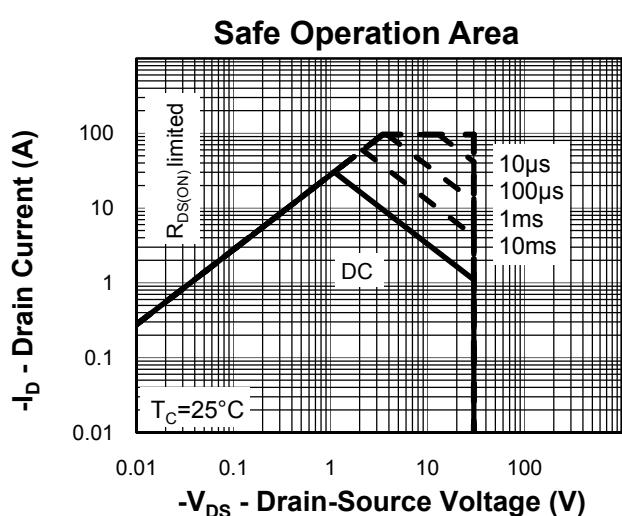
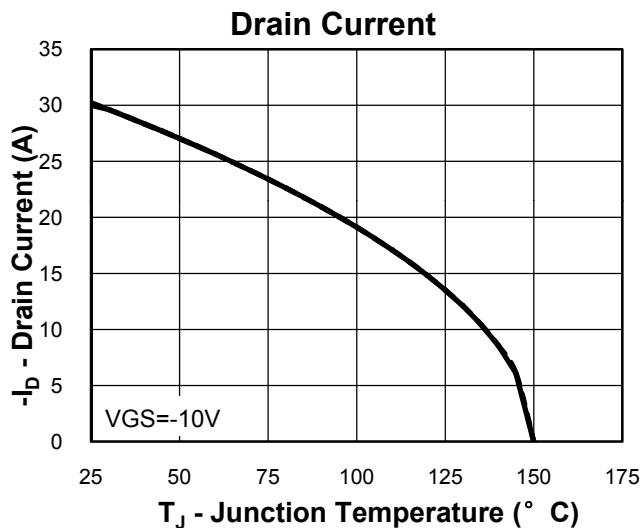
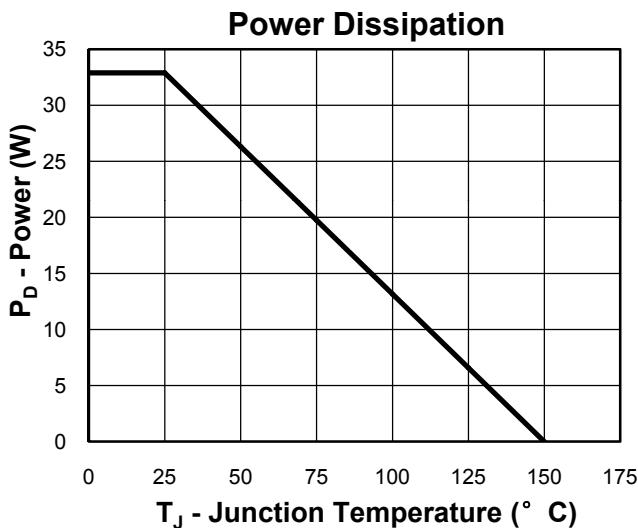
Notes:

- ①Pulse width limited by safe operating area.
- ②Calculated continuous current based on maximum allowable junction temperature.
- ③When mounted on 1 inch square copper board, $t \leq 10\text{sec}$.
- ④Limited by $T_{J\max}$, $I_{AS}=-12A$, $V_{DD}=-24V$, $R_G=50\Omega$, Starting $T_J = 25^\circ\text{C}$.
- ⑤Pulse test; Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- ⑥Guaranteed by design, not subject to production testing.

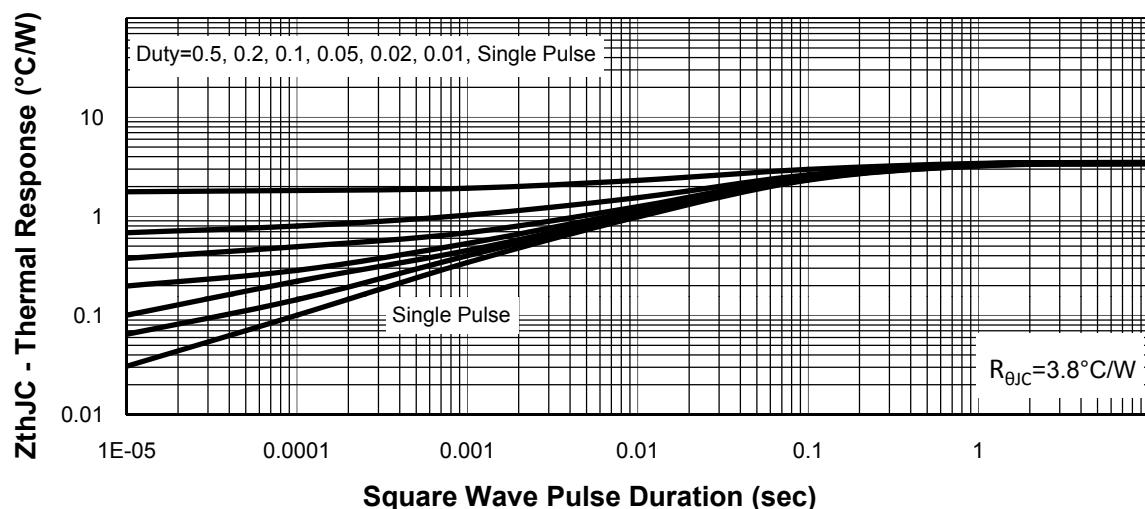
Ordering and Marking Information

Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
RU30L30M3	RU30L30	DFN3030	Tape&Reel	5000	13"	12mm

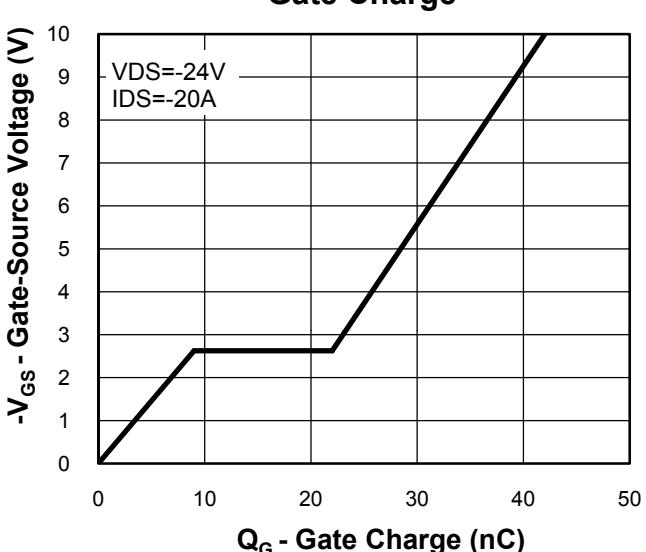
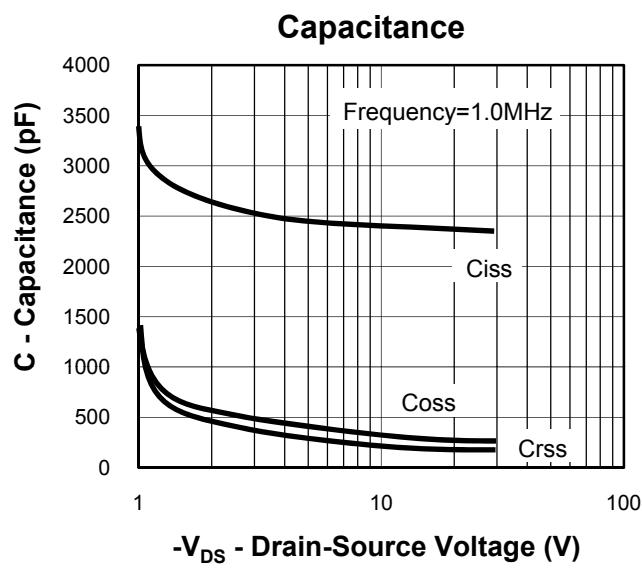
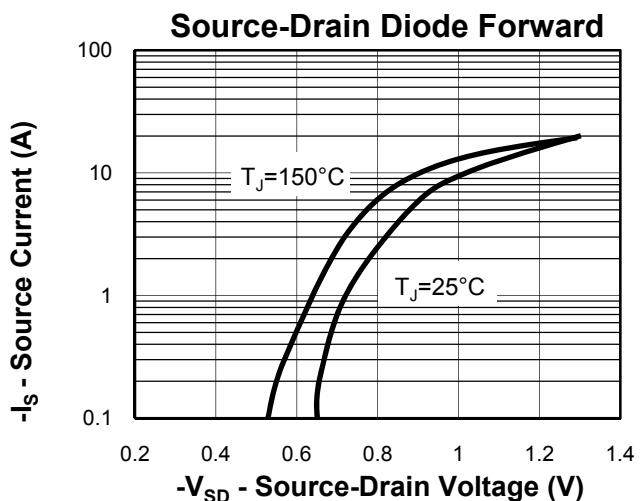
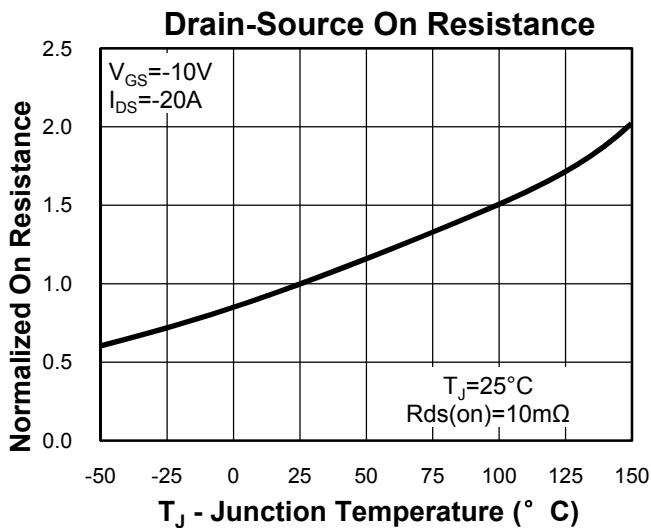
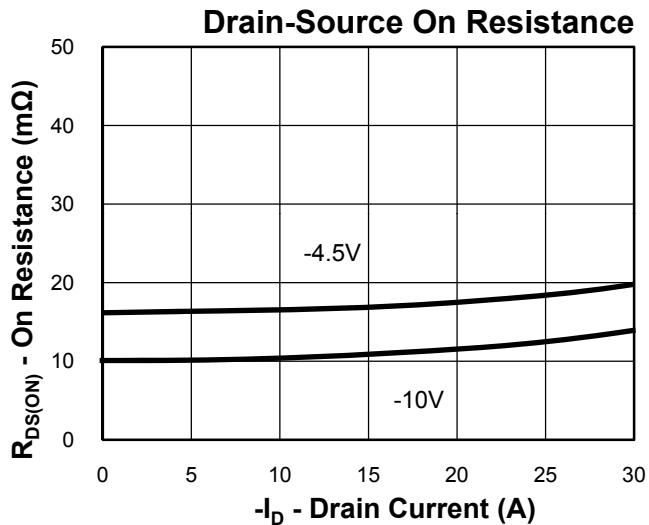
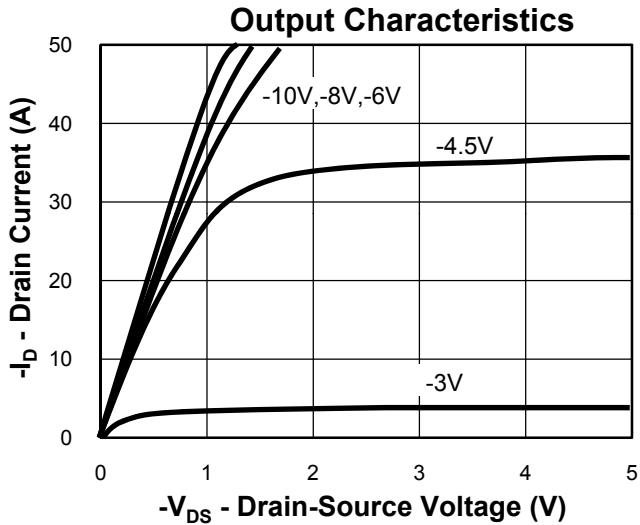
Typical Characteristics



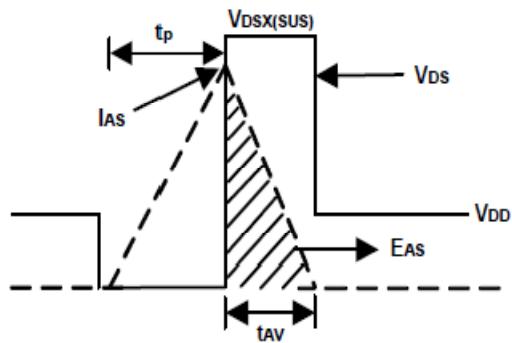
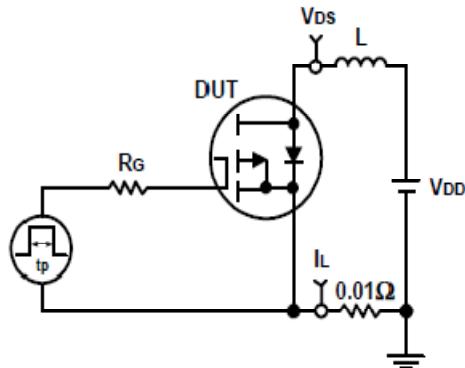
Thermal Transient Impedance



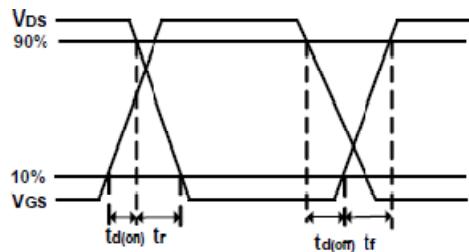
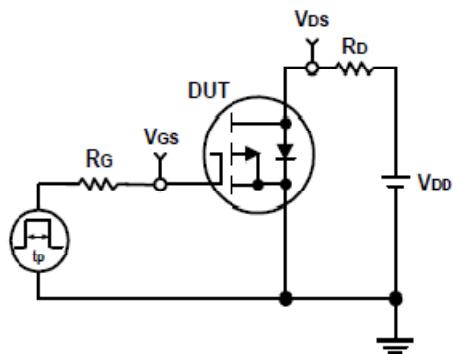
Typical Characteristics



Avalanche Test Circuit and Waveforms

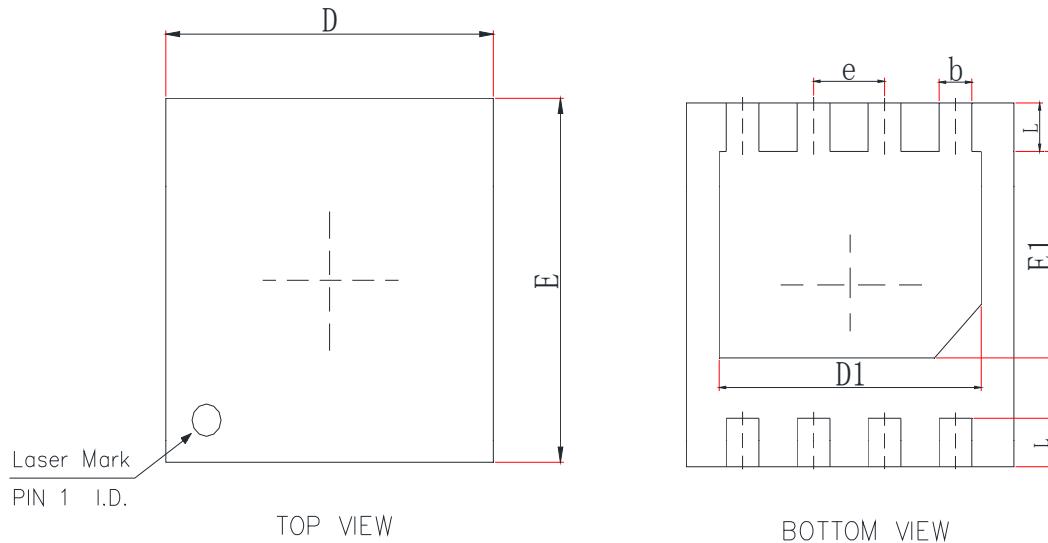


Switching Time Test Circuit and Waveforms



Package Information

DFN3030



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.031
A1			0.05			0.002
b	0.25	0.30	0.35	0.010	0.012	0.014
c	0.18	0.20	0.30	0.007	0.008	0.012
D	2.95	3.00	3.15	0.116	0.118	0.124
E	2.95	3.00	3.15	0.116	0.118	0.124
D1	2.30	2.40	2.50	0.091	0.094	0.098
E1	1.70	1.80	1.90	0.067	0.071	0.075
L	0.30	0.40	0.50	0.012	0.016	0.020
e	0.65 BSC			0.026 BSC		